## Red/Green



### **Features**

- · Available on tape and reel
- · Reliable and robust
- Pb free
- Lead Free

### **Applications**

# TV setMonitor

Telephone

Computer

## RoHS Compliant

### **Specifications**

Dice material : AlGaInP / InGaN
Emmiting Colour : Red / Green
Lens colour : White Diffused
Luminous intensity : 40mcd

### **Selection Guide**

Part Number	Dice	Lens Type	Luminous intensity(mcd) @ 20mA			Viewing Angle	
			Min	Тур	Max	2θ1/2	
MP008294	(R) AlGalnP	White Diffused	15	40	-	60	
WP006294	(G) InGaN		20	40	-	00	

#### Note:

### Electrical and Optical Characteristics at Ta=25°C

Parameter	Device	Min.	Тур	Max	Units	Test conditions
Forward voltage	R	1.7	2	2.4	V	IF=20mA
	G	1.7	2	2.4		
Reverse Current	IR	-	-	10	uA	VR=5V
Dominant wavelength	R	620	-	630	nm	IF=20mA
Dominant wavelength	G	565	-	575		

### Absolute Maximum Ratings at Ta=25°C

Parameter	Symbol	Rating	Units
Power Dissipation	Pd	60	mW
DC Forward Current	IF	30	mA
Peak Forward Current [1]	IFP	60	mA
Reverse Voltage	VR	5	V
Electrostatic Discharge (HBM)	ESD	2000	V
Operating Temperature	Topr	-40 to +85	°C
Storage Temperature	Tstg	-40 to +100	°C
Lead Soldering Temperature [1.6mm(.063") From Body]		260°C for 5	seconds

### Notes:



<sup>1.1/2</sup> is the angle from optical centerline where the luminous intensity is 1/2 the optical centerline value.

<sup>2.</sup> The above luminous intensity measurement allowance tolerance ±15%

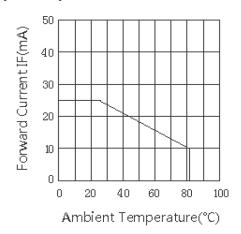
<sup>1. 1/10</sup> Duty cycle,0.1ms pulse width.

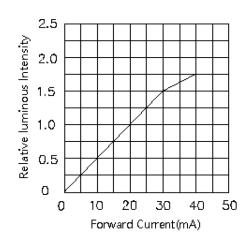
<sup>2.</sup> Measurement tolerance: Forward Voltage:±0.1V,Luminous Intensity:±10%mcd,Wavelength(x,y)±1nm/±0.01

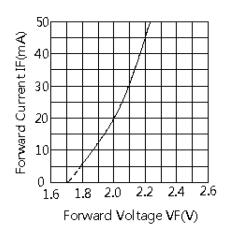
## Red/Green

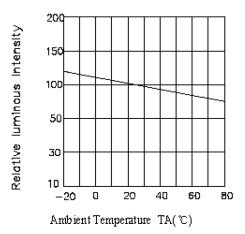
# multicomp PRO

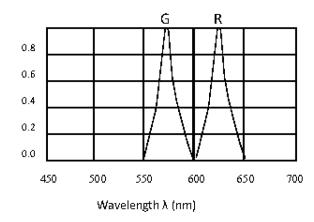
### Typical optical characteristics curves

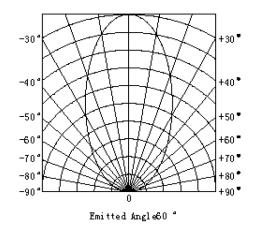










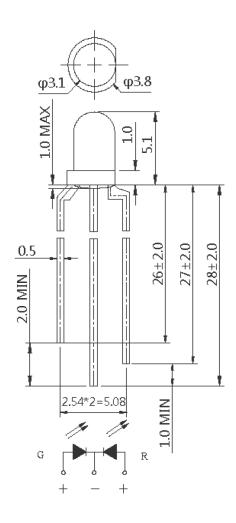




## Red/Green



### **Dimensions**



Notes

Tolerance is ±0.25mm unless otherwise noted

Dimensions: Millimetres

### Soldering

- When soldering leave a minimum of 2mm clearance from the base of the lens to the soldering point.
- · Dipping the lens into the solder must be avoided.
- Do not apply any external stress to the lead frame during soldering while the LED is at high temperature.

### Recommended soldering conditions:

Solderi	ng iron	Wave soldering		
Temperature	320°C Max	Pre-heat Pre-heat time	120°C Max 120 sec.Max	
Soldering time 3 sec.Max (one time only)		Solder wave Soldering time	260°C Max 5 sec.Max	

Note: Excessive soldering temperature and/or time might result in deformation of the LED lens or catastrophic failure of the LED.



### Red/Green

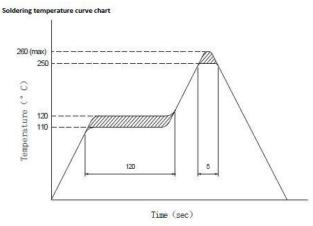


#### **Drive Method**

An LED is a current-operated device, In order to ensure intensity uniformity on multiple LEDs connected in parallel in an application, it is recommended that a current limiting resistor be incorporated in the drive circuit, in series with each LED as shown in Circuit A below.



- (A) Recommended circuit
- (B) The brightness of each LED might appear different due to the differences in the I-V characteristics of those LEDs.



### **NOTES**

After soldering the LEDs, the epoxy bulb should be protected from mechanical shock or vibration until the LEDs return to room temperature. A rapid-rate process is not recommended for cooling the LEDs down from the peak temperature.

### **Part Number Table**

Description	Part Number
Round LED, Red/Geen, 630/575nm, 60°, 40/40mcd, Through hole	MP008294

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